

**PATENT ASSIGNMENT**

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Takashi KONO	02/10/2010
Ken MATSUBARA	02/05/2010
Takashi IWASE	02/05/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	RENESAS TECHNOLOGY CORP.
<b>Street Address:</b>	6-2, Otemachi 2-chome, Chiyoda-ku,
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12766603
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	067237-0584
<b>NAME OF SUBMITTER:</b>	Bernard P. Codd
<b>Total Attachments: 2</b> source=0672370584assignmenttransmittal#page1.tif source=0672370584assignment#page1.tif	

CH \$40.00 12766603

RECORDATION FORM COVER SHEET

**Docket No.: 067237-0584**

**PATENTS ONLY**

To the Director of the U. S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

**1. Name of Conveying Party(ies)**  
**Takashi KONO, Ken MATSUBARA, Takashi IWASE**  
 Additional name(s) of conveying party(ies) attached?  Yes  No

**2. Name and address of receiving party(ies)**  
 Name: **RENESAS TECHNOLOGY CORP.**  
 Internal Address:  
 Address: **6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, JAPAN**

**3. Nature of Conveyance/Execution Date(s)**  
 Execution Date(s): **February 10, 2010; February 5, 2010 and February 5, 2010 respectively**  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Joint Research Agreement  
 Government Interest Assignment  
 Executive Order 9424, Confirmatory License  
 Other

Additional name(s) & address(es) attached?  Yes  No

**4. Application or patent number(s):**  
 A. Patent Application No(s).

This document is being filed together with a new application.  
 B. Patent No(s).

Additional numbers attached?  Yes  No

**5. Name and address to whom correspondence concerning document should be mailed:**  
 Name: **MCDERMOTT WILL & EMERY LLP**  
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**6. Total number of applications and patents involved:**  
**7. Total fee (37 CFR 1.21(h) & 3.41) \$40.00**  
 Authorized to be charged by credit card  
 Authorized to be charged to deposit account  
 Enclosed  
 None required (government interest not affecting title)

**8. Payment Information:**  
 a. Credit Card Last 4 Numbers \_\_\_\_\_  
 Expiration Date \_\_\_\_\_  
 b. Deposit Account Number 500417  
 Authorized User Name \_\_\_\_\_

**9. Signature.**  
**Stephen A. Becker 26,527** *Bernard P. Codd (Reg. No. 46429)* **April 23, 2010**  
 Name and Registration No. of Person Signing Signature Date  
 Total number of pages including cover sheet, attachments and documents: **2**

ASSIGNMENT  
(讓渡証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Renesas Technology Corp., a corporation organized under the laws of Japan, located at 6-2, Otemachi 2-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said Renesas Technology Corp., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

NONVOLATILE SEMICONDUCTOR MEMORY DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Renesas Technology Corp., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Renesas Technology Corp.

Signed on the date(s) indicated aside our signatures:

INVENTOR(S) (発明者フルネームサイン)	Date Signed (署名日)
1) <u>Takashi KONO</u> Takashi KONO	<u>10/February/2010</u>
2) <u>Ken MATSUBARA</u> Ken MATSUBARA	<u>5/February/2010</u>
3) <u>Takashi IWASE</u> Takashi IWASE	<u>5/February/2010</u>
4) _____	_____
5) _____	_____
6) _____	_____
7) _____	_____
8) _____	_____
9) _____	_____
10) _____	_____

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